

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
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<table border="1"> <tr> <td>Name:</td> <td>Sino-American Silicon Products, Inc.</td> </tr> <tr> <td>Street Address:</td> <td>No. 8, Industrial East Road 2.</td> </tr> <tr> <td>Internal Address:</td> <td>Science-Based Industrial Park</td> </tr> <tr> <td>City:</td> <td>Hsinchu</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> <tr> <td>Postal Code:</td> <td>30075</td> </tr> </table>		Name:	Sino-American Silicon Products, Inc.	Street Address:	No. 8, Industrial East Road 2.	Internal Address:	Science-Based Industrial Park	City:	Hsinchu	State/Country:	TAIWAN	Postal Code:	30075
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CORRESPONDENCE DATA													
<p>Fax Number: (858)847-0017</p> <p>Phone: 8584811883</p> <p>Email: kathy.wojtalewicz@themuellerlawoffice.com</p> <p><i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: Kathy Wojtalewicz</p> <p>Address Line 1: 12707 High Bluff Drive, Ste. 200</p> <p>Address Line 4: San Diego, CALIFORNIA 92130</p>													
ATTORNEY DOCKET NUMBER:	SAINP031												

NAME OF SUBMITTER:

Kathy Wojtalewicz

Total Attachments: 2

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ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title)
METHOD FOR PATTERNING AN EPITAXIAL SUBSTRATE, A LIGHT
EMITTING DIODE AND A METHOD FOR FORMING A LIGHT EMITTING
DIODE

The PATENT RIGHTS referred to in this agreement are:

(check one) ☒ a patent application for this invention, executed by the
ASSIGNOR(S) concurrently with this assignment.

☐ U.S. patent application Serial No. _____, filed _____

☐ a U.S. patent application based on PCT International Application
No. _____, filed on (date) _____ (U.S. patent
application Serial No. _____, if known)

☐ U.S. Patent No. _____, issued _____

The PATENT RIGHTS also include all divisions, reissues, continuations and
extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) ☒ U.S. patent rights only.

☐ Worldwide patent rights. In this case, the assignee shall have the
right to claim the benefit of the filing date of any U.S. or foreign
patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose
signature(s) appear(s) on page 2 of this Assignment and any Supplemental Sheets(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) Sino-American Silicon Products Inc.

(Address) No. 8, Industrial East Road 2, Science-Based Industrial Park, Hsinchu
30075, Taiwan

The ASSIGNEE is:

(check one) ☐ An Individual.

☐ A Partnership.

☒ A Corporation of Taiwan (specify state or country)

☐ (other) _____

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other
good and valuable consideration, receipt of which is acknowledged, hereby assign(s)
the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;
the entire right, title and interest in and to the PATENT RIGHTS;
the right to sue and recover for any past infringement; and,
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) any attorney and agent who has a power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

<u>Cheng-Hung WEI</u>	<u>Cheng-Hung Wei</u>	<u>April 10, 2012</u>
Name of sole or first inventor	Signature	Date

<u>Bo-Wen LIN</u>	<u>Bo-Wen Lin</u>	<u>April 10, 2012</u>
Name of second inventor, if any	Signature	Date

<u>Ching-Yen PENG</u>	<u>Ching-Yen Peng</u>	<u>April 10, 2012</u>
Name of third inventor, if any	Signature	Date

<u>Hao-Chung KUO</u>	<u>Hao-Chung Kuo</u>	<u>April 10, 2012</u>
Name of fourth inventor, if any	Signature	Date

<u>Wen-Ching HSU</u>	<u>Wen-Ching Hsu</u>	<u>April 10, 2012</u>
Name of fifth inventor, if any	Signature	Date